

	8	7	6	5	4	3	2	1		
F	12.55±0.38	30.81±0.38	24.99±0.13	16.90±0.25	10.95	No. of Contact	A ±0.25 A ±.010	B ±0.13 B ±.005	C ±0.38 C ±.015	D ±0.25 D ±.010
E	8.36±0.13	4.00±0.25	#4-4.0 UNC	6.10	4.05±0.25	15	16.90 0.666	24.99 0.984	30.81 1.213	24.99 .984
D						26	24.66 0.971	33.32 1.312	39.14 1.541	33.32 1.312
C						44	38.38 1.511	47.04 1.852	53.04 2.088	47.04 1.852
B						62	54.84 2.159	63.50 2.500	69.32 2.729	63.50 2.500

ELECTRICAL CHARACTERISTICS

CONTACT CURRENT RATING : 5.0 AMPS
 CONTACT RESISTANCE : 30 MILLIOHMS MAX.
 DIELECTRIC WITHSTANDING VOLTAGE : 1000 V AC MIN.
 INSULATION RESISTANCE : 5000 MEGAOHMS MIN.
 TEMPERATURE RATING : -55°C ~ +105°C

PART NO:

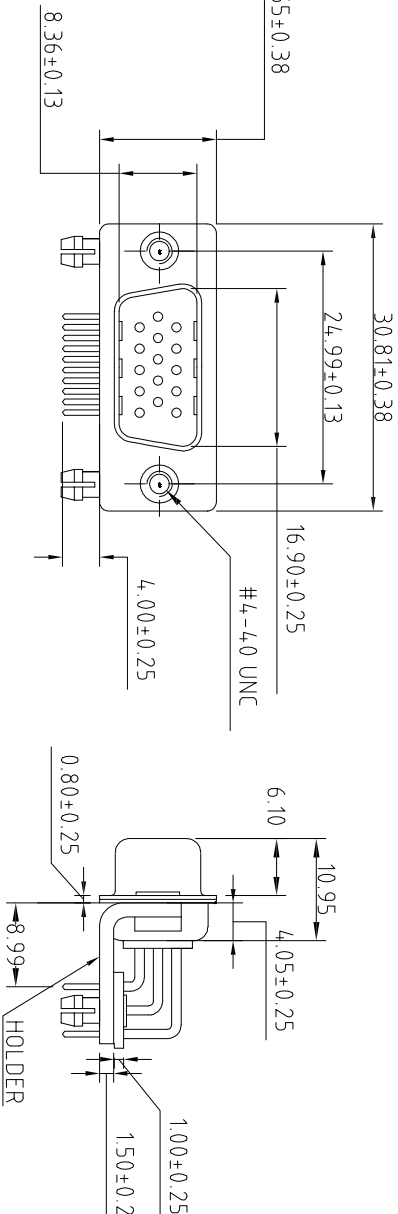
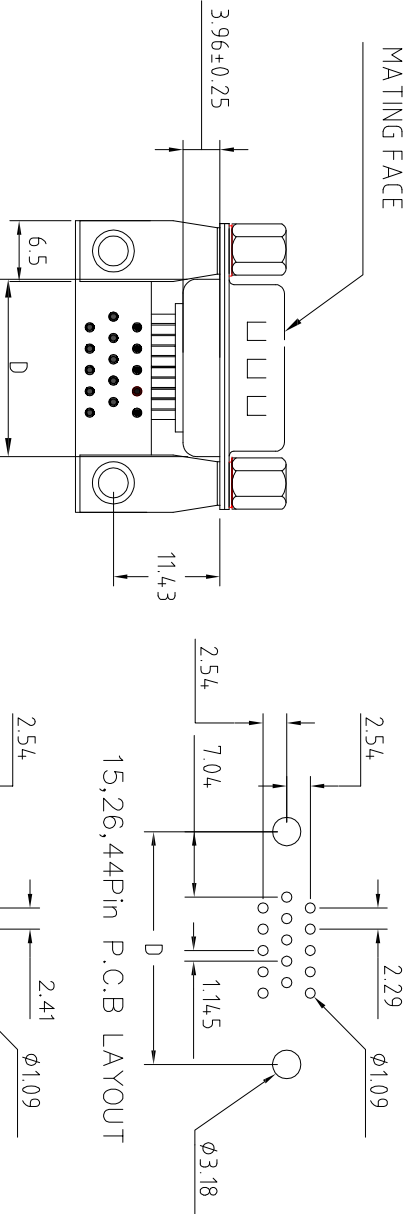
B04-0XX5X14D-02

NO. OF CONTACT:

15 = 15 pos
 26 = 26 pos
 44 = 44 pos
 62 = 62 pos

HOUSING COLOR:

1 = BLACK
 5 = WHITE



ITEM	DESC.	MATERIAL	REMARKS	PART REMARKS
5	SCREW	STEEL	PALTING: NI	
4	BOARDLOCK	COPPER ALLOY	PALTING: NI	
3	HOUSING	PBT+30%GF	COLOR: BLACK	
2	SHELL	SPCC	PALTING: NI	
1	TERMINAL	COPPER ALLOY	CONTACT AREA: Au 2u" SOLDER AREA: Au 2u" UNDER-PLATING: NI	

NAME: H-D-SUB Male R/A Type For PCB
 PART NO. B04-0XX5514D-02

62Pin P.C.B LAYOUT

REV:	A	UNIT:	mm	DRW BY	CHK BY	APP BY	DRAWING NO.	
SCALE:	N:1	DATE:	2018/03/11	Huangmei	Jack Chen		B10-037	
QUALITY SYMBOLS	□:	⊗:	Tolerance					
CRITICAL	▽:	MAJOR	±0.60 ±0.40 ±0.25					
ZERO DEFECT S.P.C	▽:							
APPROVER	Jack Chen							
DESCRIPTION	NEW ISSUE							
DATE	2018/03/11							
SIDE	8	7	6	5	4	3	2	1